01/23/2015 503147892

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3194504

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ATSUO ISOBE	01/25/2013
KUNIO HOSOYA	01/28/2013

RECEIVING PARTY DATA

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14578578

CORRESPONDENCE DATA

Fax Number: (877)769-7945

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (202) 783-5070 Email: APSI@fr.com Correspondent Name: JOHN F. HAYDEN

Address Line 1: FISH & RICHARDSON P.C.

Address Line 2: P.O.BOX 1022

Address Line 4: MINNEAPOLIS, MINNESOTA 55440-1022

ATTORNEY DOCKET NUMBER:	12732-1136002	
NAME OF SUBMITTER: JANELLE A. JACKSON		
SIGNATURE:	/Janelle A. Jackson/	
DATE SIGNED:	01/23/2015	

Total Attachments: 1

source=Assignment 12732-1136002#page1.tif

PATENT REEL: 034795 FRAME: 0426 503147892

Attorney Docket No. 12732-1136001 Client Reference No. US16471

ASSIGNMENT

For valuable consideration, We, <u>Atsuo ISOBE of Ischara</u>, <u>Kanagawa</u>, <u>Japan and Kunio HOSOYA of Atsugi</u>, <u>Kanagawa</u>, <u>Japan hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:</u>

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and
interest throughout the world in the inventions and improvements which are subject of an application for
United States Patent signed by us this day, entitled METHOD FOR MANUFACTURING
SEMICONDUCTOR DEVICE, filed January 31, 2013 , and assigned U.S. Serial
Number 13/755,862 and we authorize and request the attorneys appointed in said application
to hereafter complete this assignment by inserting above the filing date and serial number of said application
when known; this assignment including said application, any and all United States and foreign patents, utility
models, and design registrations granted for any of said inventions or improvements, and the right to claim
priority based on the filing date of said application under the International Convention for the Protection of
Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of
like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for
patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said
inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and
assigns, without further compensation to perform such lawful acts and to sign such further applications,
assignments, Preliminary Statements and other lawful documents as the Assignce may reasonably request to
effectuate fully this assignment.

Signature	Atsuo	Ishe	
Name:	Atsuo ISOBE		
Date:	01/25/2013		
Signature	<u> KUNIO</u>	1-10501/0-	
Name:	Kunio HOSOYA	ξ	
Date:	01/28/20(3		

RECORDED: 01/23/2015

PATENT REEL: 034795 FRAME: 0427